

bq27421-G1

Technical Reference



Literature Number: SLUUAC5
June 2013

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Preface

This document is a detailed Technical Reference Manual (TRM) for using and configuring the bq27421-G1 battery fuel gauge. This TRM document is intended to complement but not supersede any information contained in the separate bq27421-G1 datasheet.

Refer to the [bq27421-G1 Datasheet \(SLUSB85\)](#).

Another useful reference document is the [bq27421-G1 Quick Start Guide \(SLUUAH7\)](#).

Formatting conventions used in this document:

Information Type	Formatting Convention	Example
Commands	<i>Italics with parentheses and no breaking spaces</i>	<i>RemainingCapacity()</i> command
Data Memory	<i>Italics, bold, and breaking spaces</i>	Design Capacity data
Register bits and flags	Brackets only	[SOC1] bit
Data Memory bits	Brackets, <i>italics</i> , and bold	[TEMPS] bit
Modes and states	ALL CAPITALS	UNSEALED mode

Revision History

Version	Change Date	Description
—	June 2013	Initial Release

General Description

The bq27421-G1 battery fuel gauge accurately predicts the battery capacity and other operational characteristics of a single Li-based rechargeable cell. It can be interrogated by a system processor to provide cell information, such as state-of-charge (SOC). The device is orderable in two pre-defined standard configurations:

- bq27421-G1A is pre-defined for LiCoO₂-based batteries for 4.2 V max charge voltage.
- bq27421-G1B is pre-defined for LiMn₂O₄-based batteries for 4.3V or 4.35V max charge voltages.

Unlike some other Impedance Track™ fuel gauges, the bq27421-G1 can not be programmed with specific battery chemistry profiles. For many battery types and applications, the pre-defined standard chemistry profiles available in the bq27421-G1A or bq27421-G1B are sufficient matches from a gauging perspective.

Information is accessed through a series of commands, called *Standard Commands*. Further capabilities are provided by the additional *Extended Commands* set. Both sets of commands, indicated by the general format *Command()*, are used to read and write information contained within the bq27421-G1 control and status registers, as well as its data locations. Commands are sent from system to gauge using the bq27421-G1's I²C serial communications engine, and can be executed during application development, system manufacture, or end-equipment operation.

The key to the bq27421-G1's high-accuracy fuel gauging prediction is Texas Instrument's proprietary Impedance Track™ algorithm. This algorithm uses cell measurements, characteristics, and properties to create state-of-charge predictions that can achieve high accuracy across a wide variety of operating conditions and over the lifetime of the battery.

The bq27421-G1 measures charge/discharge activity by monitoring the voltage across a small-value integrated sense resistor. Cell impedance is computed based on current, open-circuit voltage (OCV), and cell voltage under loading conditions.

The bq27421-G1 uses an integrated temperature sensor for estimating cell temperature. Alternatively, the system processor can provide temperature data for the bq27421-G1.

To minimize power consumption, the bq27421-G1 has several power modes: INITIALIZATION, NORMAL, SLEEP, HIBERNATE and SHUTDOWN. The bq27421-G1 passes automatically between these modes, depending upon the occurrence of specific events, though a system processor can initiate some of these modes directly.

Functional Description

2.1 Fuel Gauging

The bq27421-G1 battery fuel gauge measures the cell voltage, temperature, and current to determine battery SOC. The fuel gauge monitors charge and discharge activity by sensing the voltage across a small-value integrated resistor (7 mΩ typical) between the BAT and SRX pins. By integrating the charge passing through the battery, the battery SOC is adjusted during battery charge or discharge.

The total battery capacity is found by comparing states of charge before and after applying the load with the amount of charge passed. When an application load is applied, the impedance of the cell is measured by comparing the OCV obtained from a predefined function for present SOC with the measured voltage under load. Measurements of OCV and charge integration determine chemical state of charge and chemical capacity (Qmax). The initial value for Qmax is defined by **Design Capacity** and should match the cell manufacturers' data sheet. The fuel gauge acquires and updates the battery-impedance profile during normal battery usage. The impedance profile, along with SOC and the Qmax value, are used to determine *FullChargeCapacity()* and *StateOfCharge()*, specifically for the present load and temperature. *FullChargeCapacity()* is reported as capacity available from a fully-charged battery under the present load and temperature until *Voltage()* reaches the **Terminate Voltage**. *NominalAvailableCapacity()* and *FullAvailableCapacity()* are the uncompensated (no or light load) versions of *RemainingCapacity()* and *FullChargeCapacity()*, respectively.

The bq27421-G1 has two flags, [SOC1] and [SOCF], accessed by the *Flags()* command that warns when the battery SOC has fallen to critical levels. When *RemainingCapacity()* falls below the first capacity threshold, specified in **SOC1 Set Threshold**, the [SOC1] (state of charge initial) flag is set. The flag is cleared once *RemainingCapacity()* rises above **SOC1 Set Threshold**. All units are in mAh.

When *RemainingCapacity()* falls below the second capacity threshold, **SOCF Set Threshold**, the [SOCF] (state of charge final) flag is set, serving as a final discharge warning. If **SOCF Set Threshold** = -1, the flag is inoperative during discharge. Similarly, when *RemainingCapacity()* rises above **SOCF Clear Threshold** and the [SOCF] flag has already been set, the [SOCF] flag is cleared. All units are in mAh.

2.2 Temperature Measurement

The fuel gauge measures temperature via its internal on-chip sensor. This internal temperature data will be used for the data for Impedance Track™ algorithm purposes if the **OpConfig [TEMPS]** bit is cleared. Alternatively, if **OpConfig [TEMPS]** bit is set, the system processor can set the temperature for the fuel gauging algorithm.

Regardless of which sensor is used for measurement, the system processor can request the current battery temperature by calling the *Temperature()* function.

2.3 Current Measurement

The fuel gauge measures current sensing the voltage across a small-value integrated resistor (7 mΩ typical) between the BAT and SRX pins. Internally, voltage passes through a gain stage before conversion by the coulomb counter. The current measurement data is available via the *AverageCurrent()* command.

Note: The long-term RMS current limit is 2000mA max with up to 3500 mA peak. For details, refer to the [bq27421-G1 Datasheet \(SLUSB85\)](#).

2.4 OPERATING MODES

The fuel gauge has different operating modes: POR, INITIALIZATION, NORMAL, CONFIG UPDATE, SLEEP, and HIBERNATE. Upon power up from OFF or SHUTDOWN, a Power On Reset (POR) occurs and the fuel gauge begins INITIALIZATION. In NORMAL mode, the bq27421-G1 is fully powered and can execute any allowable task. Configuration data in RAM can be updated by the host using the CONFIG UPDATE mode. In SLEEP mode the fuel gauge turns off the high frequency oscillator clock to enter a reduced-power state, periodically taking measurements and performing calculations. In HIBERNATE mode the bq27421-G1 is in a very low power state, but can be woken up by communication or certain I/O activity.

In SHUTDOWN mode, the LDO is disabled so internal power and all RAM-based volatile data is lost. Since no gauging occurs in SHUTDOWN mode, additional gauging error can be introduced if the system has significant battery charge/discharge activity prior to re-INITIALIZATION.

2.4.1 POR and INITIALIZATION Modes

Upon Power On Reset (POR), the fuel gauge copies ROM-based configuration defaults to RAM and begins INITIALIZATION mode where essential data is initialized and will remain in INITIALIZATION mode as halted-CPU state when an adapter, or other power source is present to power the bq27421-G1 (and system), yet no battery has been detected. The occurrence of POR or a *Control()* RESET subcommand will set the *Flags()* [ITPOR] status bit to indicate that RAM has returned to ROM default data. When battery insertion is detected, a series of initialization activities begin including an OCV measurement. In addition CONTROL_STATUS[QMAX_UP] and [RES_UP] bits are cleared to allow fast learning of Qmax and impedance.

Some commands, issued by a system processor, can be processed while the fuel gauge is halted in this mode. The gauge will wake up to process the command, and then return to the halted state awaiting battery insertion. The current consumption of INITIALIZATION mode is similar to NORMAL mode.

2.4.2 CONFIG UPDATE Mode

If the application requires different configuration data for the fuel gauge, the system processor can update RAM-based Data Memory parameters using the *Control()* SET_CFGUPDATE subcommand to enter CONFIG UPDATE mode as indicated by the *Flags()* [CFGUPMODE] status bit. In this mode, fuel gauging is suspended while the host uses the Extended Data Commands to modify the configuration data blocks. To resume fuel gauging, the host sends a *Control()* SOFT_RESET subcommand to exit CONFIG UPDATE mode and clear both *Flags()* [ITPOR] and [CFGUPMODE] bits. After a timeout of approximately 240 seconds (4 minutes), the gauge will automatically exit CONFIG UPDATE mode if it has not received a SOFT_RESET subcommand from the host.

2.4.3 NORMAL Mode

The fuel gauge is in NORMAL mode when not in any other power mode. During this mode, *AverageCurrent()*, *Voltage()* and *Temperature()* measurements are taken once per second, and the interface data set is updated. Decisions to change states are also made. This mode is exited by activating a different power mode.

Because the gauge consumes the most power in NORMAL mode, the Impedance Track™ algorithm minimizes the time the fuel gauge remains in this mode.

2.4.4 SLEEP Mode

SLEEP mode is entered automatically if the feature is enabled (*OpConfig[SLEEP]* = 1) and *AverageCurrent()* is below the programmable level **Sleep Current** (default = 10mA). Once entry into SLEEP mode has been qualified, but prior to entering it, the fuel gauge performs an ADC autocalibration to minimize offset.

During SLEEP mode, the fuel gauge remains in a very low power idle state and automatically wakes up briefly every 20 seconds to take data measurements.

After making the measurements on the 20 second interval, the fuel gauge will exit SLEEP mode when *AverageCurrent()* rises above **Sleep Current** (default = 10mA). Alternatively, an early wake-up before the 20 second interval is possible if the instantaneous current is detected by an internal hardware comparator above an approximate threshold of ± 30 mA.

2.4.5 HIBERNATE Mode

HIBERNATE mode could be used when the system equipment needs to enter a very low-power state, and minimal gauge power consumption is required. This mode is ideal when a system equipment is set to its own HIBERNATE, SHUTDOWN, or OFF modes.

Before the fuel gauge can enter HIBERNATE mode, the system must set the [*HIBERNATE*] bit of the CONTROL_STATUS register. The gauge waits to enter HIBERNATE mode until it has taken a valid OCV measurement and the magnitude of the average cell current has fallen below **Hibernate Current**. The gauge can also enter HIBERNATE mode if the cell voltage falls below the **Hibernate Voltage**. The gauge will remain in HIBERNATE mode until the system issues a direct I²C command to the gauge. I²C communication that is not directed to the gauge will only briefly wake it up and the gauge immediately returns to HIBERNATE mode.

It is the system's responsibility to wake the fuel gauge after it has gone into HIBERNATE mode and to prevent a charger from charging the battery before the [OCVTAKEN] bit is set which signals an OCV reading is taken. After waking, the gauge can proceed with the initialization of the battery information. During HIBERNATE mode, RAM-based data values are maintained, but gauging status is lost. Upon exit from HIBERNATE mode, the gauge will immediately re-acquire measurements and re-initialize all gauging predictions.

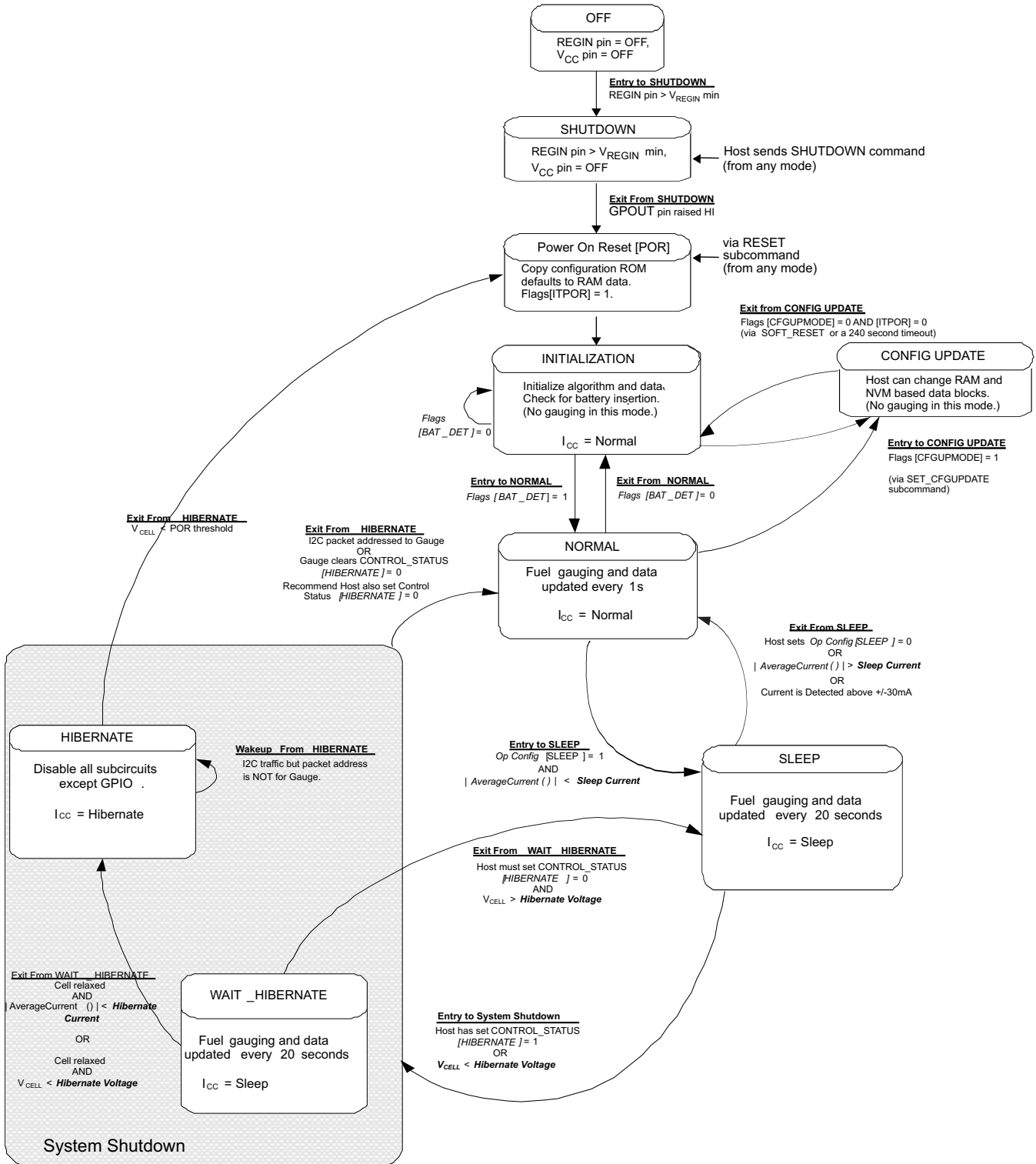


Figure 2-1. Power Mode Diagram

2.5 Pin Descriptions

2.5.1 GPOUT Pin

The GPOUT Pin is a multiplex pin and the polarity of the pin output can be selected via the `[GPIO_POL]` bit of `OpConfig`. The function is defined by `[BATLOWEN]`. If set, the Battery Low Indicator (BAT_LOW) function for GPOUT pin is selected. If cleared, the SOC interrupt (SOC_INT) function is selected for GPOUT.

When the BAT_LOW function is activated, the signaling on the multiplexed pin follows the status of the `[SOC1]` bit in the `Flags()` register. The bq27421-G1 has two flags accessed by the `Flags()` function that warns when the battery's SOC has fallen to critical levels. When `StateOfCharge()` falls below the first capacity threshold, specified in **SOC1 Set Threshold**, the `[SOC1]` (*State of Charge Initial*) flag is set. The flag is cleared once `StateOfCharge()` rises above **SOC1 Set Threshold**. The bq27421-G1's GPOUT pin automatically reflects the status of the `[SOC1]` flag when `OpConfig[BATLOWEN=0]`.

When `StateOfCharge()` falls below the second capacity threshold, **SOCF Set Threshold**, the `[SOCF]` (*State of Charge Final*) flag is set, serving as a final discharge warning. Similarly, when `StateOfCharge()` rises above **SOCF Clear Threshold** and the `[SOCF]` flag has already been set, the `[SOCF]` flag is cleared.

When the SOC_INT function is activated, the GPOUT pin generates 1ms pulse width under various conditions as described in [Table 2-1](#).

Table 2-1. SOC_INT Function Definition

	Enable Condition	Pulse Width	Description
Change in SOC	(SOC1 Delta) ≠ 0	1ms	During charge, when the SOC is greater than (>) the points, 100% - n × (SOC1 Delta) and 100%; During discharge, when the SOC reaches (≤) the points 100% - n × (SOC1 Delta) and 0%; where n is an integer starting from 0 to the number generating SOC no less than 0% Examples: For SOC1 Delta = 1% (default), the SOC_INT intervals are 0%, 1%, 2%, 99%, and 100%. For SOC1 Delta = 10%, the SOC_INT intervals are 0%, 10%, 20%, 90%, and 100%.
State Change	(SOC1 Delta) ≠ 0	1ms	Upon detection of entry to a charge or a discharge state. Relaxation is not included.
Battery Removal	<code>[BIE]</code> bit is set in <code>OpConfig</code>	1ms	When battery removal is detected by BIN pin.

2.5.2 Battery Detection (BIN)

The function of `OpConfig[BIE]` bit is described in the [Table 2-2](#) table below. When battery insertion is detected and INITIALIZATION mode is completed, the bq27421-G1 transitions to NORMAL mode to start Impedance Track™ fuel gauging. When battery insertion is not detected, the bq27421-G1 remains in INITIALIZATION mode.

Table 2-2. Battery Detection

<code>OpConfig[BIE]</code>	Battery Insertion Requirement	Battery Removal Requirement
1	(1) Host drives BIN pin from logic high to low to signal battery insertion. or (2) A weak pull-up resistor can be used (between BIN and VCC pin). When battery pack with pull-down is connected, it can generate a logic low to signal battery insertion.	(1) Host drives BIN pin from logic low to high to signal battery removal. or (2) When battery pack with pull-down is removed, the weak pull-up resistor can generate a logic high to signal battery removal.
0	Host sends BAT_INSERT subcommand to signal battery insertion.	Host sends BAT_REMOVE subcommand to signal battery removal.

Application Examples

3.1 Data Memory Parameter Update Example

The following example shows the command sequence needed to modify a Data Memory parameter. For this example, the default **Design Capacity** is updated from 1000 mAh to 1200 mAh. All device writes (wr) and reads (rd) are implied to I2C 8-bit addresses 0xAA and 0xAB respectively.

Step	Step Description	Pseudo Code
1	If the device has been previously SEALED, UNSEAL it by sending the appropriate keys to <i>Control()</i> (0x00 and 0x01). Write the first 2 bytes of the UNSEAL key using the <i>Control(0x8000)</i> command. Without writing any other bytes to the device, write the second (identical) 2 bytes of the UNSEAL key using the <i>Control(0x8000)</i> command. Note: Remaining steps below will use this single packet method when writing multiple bytes.	<pre>//Two-byte incremental Method wr 0x00 0x00 0x80; wr 0x00 0x00 0x80; //Alternative single byte method wr 0x00 0x00; wr 0x01 0x80; wr 0x00 0x00; wr 0x01 0x80;</pre>
2	Send SET_CFGUPDATE subcommand, <i>Control(0x0013)</i>	<pre>wr 0x00 0x13 0x00;</pre>
3	Confirm CFGUPDATE mode by polling <i>Flags()</i> register until bit 4 is set. May take up to 1 second.	<pre>rd 0x06 Flags_register;</pre>
4	Write 0x00 using <i>BlockDataControl()</i> command (0x61) to enable block data memory control.	<pre>wr 0x61 0x00;</pre>
5	Write 0x52 using the <i>DataBlockClass()</i> command (0x3E) to access the State subclass (82 decimal, 0x52 hex) containing the Design Capacity parameter.	<pre>wr 0x3E 0x52;</pre>
6	Write the block offset location using <i>DataBlock()</i> command (0x3F). Note: To access data located at offset 0 to 31 use offset = 0x00. To access data located at offset 32 to 41 use offset = 0x01.	<pre>wr 0x3F 0x00;</pre>
7	Read the 1-byte checksum using the <i>BlockDataChecksum()</i> command (0x60). Expect 0xE8 for -G1B for checksum.	<pre>rd 0x60 OLD_Csum;</pre>
8	Read both Design Capacity bytes starting at 0x4A. (offset = 10). Block data starts at 0x40, so to read the data of a specific offset, use address 0x40 + mod(offset, 32). Expect 0x03 0xE8 for -G1B for a 1000 mAh default value. Note: LSB byte is coincidentally the same value as the checksum.	<pre>rd 0x4A OLD_DesCap_MSB; rd 0x4B OLD_DesCap_LSB;</pre>
9	Write both Design Capacity bytes starting at 0x4A. (offset = 10) For this example, the new value is 1200 mAh. (0x04B0 hex)	<pre>wr 0x4A 0x04; wr 0x4B 0xB0;</pre>
10	Compute the new block checksum. The checksum is (255 – x) where x is the 8-bit summation of the <i>BlockData()</i> (0x40 to 0x5F) on a byte-by-byte basis. A quick way to calculate the new checksum uses a data replacement method with the old and new data summation bytes. Refer to the code for the indicated method.	<pre>temp = mod(255 - OLD_Csum - OLD_DesCap_MSB - OLD_DesCap_LSB, 256); NEW_Csum = 255 - mod(temp + + 0x04 + 0xB0, 256);</pre>
11	Write new checksum. The data is actually transferred to the Data Memory when the correct checksum for the whole block (0x40 to 0x5F) is written to <i>BlockDataChecksum()</i> (0x60). For this example New_Csum is 0x1F.	<pre>wr 0x60 New_Csum; //Example: wr 0x60 0x1F</pre>
12	Exit CFGUPDATE mode by sending SOFT_RESET subcommand, <i>Control(0x0042)</i>	<pre>wr 0x00 0x42 0x00;</pre>
13	Confirm CFGUPDATE has been exited by polling <i>Flags()</i> register until bit 4 is cleared. May take up to 1 second.	<pre>rd 0x06 Flags_register;</pre>
14	If the device was previously SEALED, return to SEALED mode sending by the <i>Control(0x0020)</i> subcommand.	<pre>wr 0x00 0x20 0x00;</pre>

STANDARD COMMANDS

The bq27421-G1 uses a series of 2-byte standard commands to enable system reading and writing of battery information. Each standard command has an associated command-code pair, as indicated in [Table 4-1](#). Because each command consists of two bytes of data, two consecutive I2C transmissions must be executed both to initiate the command function, and to read or write the corresponding two bytes of data.

Table 4-1. Standard Commands

NAME		COMMAND CODE	UNITS	SEALED ACCESS
<i>Control()</i>	CNTL	0x00 / 0x01	N/A	R/W
<i>Temperature()</i>	TEMP	0x02 / 0x03	0.1°K	R/W
<i>Voltage()</i>	VOLT	0x04 / 0x05	mV	R
<i>Flags()</i>	FLAGS	0x06 / 0x07	N/A	R
<i>NominalAvailableCapacity()</i>		0x08 / 0x09	mAh	R
<i>FullAvailableCapacity()</i>		0x0a / 0x0b	mAh	R
<i>RemainingCapacity()</i>	RM	0x0c / 0x0d	mAh	R
<i>FullChargeCapacity()</i>	FCC	0x0e / 0x0f	mAh	R
<i>AverageCurrent()</i>		0x10 / 0x11	mA	R
<i>StandbyCurrent()</i>		0x12 / 0x13	mA	R
<i>MaxLoadCurrent()</i>		0x14 / 0x15	mA	R
<i>AveragePower()</i>		0x18 / 0x19	mW	R
<i>StateOfCharge()</i>	SOC	0x1c / 0x1d	%	R
<i>IntTemperature()</i>		0x1e / 0x1f	0.1°K	R
<i>StateOfHealth()</i>	SOH	0x20 / 0x21	num / %	R

4.1 Control(): 0x00/0x01

Issuing a *Control()* command requires a subsequent 2-byte subcommand. These additional bytes specify the particular control function desired. The *Control()* command allows the system to control specific features of the bq27421-G1 during normal operation and additional features when the device is in different access modes, as described in [Table 4-2](#).

Table 4-2. Control() Subcommands

CNTL FUNCTION	CNTL DATA	SEALED ACCESS	DESCRIPTION
CONTROL_STATUS	0x0000	Yes	Reports the status of device.
DEVICE_TYPE	0x0001	Yes	Reports the device type (0x0421).
FW_VERSION	0x0002	Yes	Reports the firmware version of the device.
DM_CODE	0x0004	Yes	Reports the Data Memory Code number stored in NVM.
PREV_MACWRITE	0x0007	Yes	Returns previous MAC command code.
CHEM_ID	0x0008	Yes	Reports the chemical identifier of the Impedance Track™ configuration
BAT_INSERT	0x000c	Yes	Forces the <i>[BAT_DET]</i> bit set when the <i>[BIE]</i> bit is 0.
BAT_REMOVE	0x000d	Yes	Forces the <i>[BAT_DET]</i> bit clear when the <i>[BIE]</i> bit is 0.
SET_HIBERNATE	0x0011	Yes	Forces CONTROL_STATUS <i>[HIBERNATE]</i> to 1.
CLEAR_HIBERNATE	0x0012	Yes	Forces CONTROL_STATUS <i>[HIBERNATE]</i> to 0.
SET_CFGUPDATE	0x0013	No	Force CONTROL_STATUS <i>[CFGUPMODE]</i> to 1 and gauge enters CONFIG UPDATE mode.
SHUTDOWN_ENABLE	0x001b	No	Enables device SHUTDOWN mode.
SHUTDOWN	0x001c	No	Commands the device to enter SHUTDOWN mode.
TOGGLE_GPOUT	0x0023	Yes	Commands the device to toggle the GPOUT pin for 1ms.
SEALED	0x0020	No	Places the device in SEALED access mode.
RESET	0x0041	No	Performs a full device reset.
SOFT_RESET	0x0042	No	Gauge exits CONFIG UPDATE mode.

4.1.1 CONTROL_STATUS: 0x0000

Instructs the fuel gauge to return status information to control addresses 0x00/0x01. The read-only status word contains status bits that are set or cleared either automatically as conditions warrant or through using specified subcommands.

Table 4-3. CONTROL_STATUS Bit Definitions

	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
High Byte	SHUTDOWNEN	WDRESET	SS	CALMODE	CCA	BCA	QMAX_UP	RES_UP
Low Byte	INITCOMP	HIBERNATE	RSVD	SLEEP	LDMD	RUP_DIS	VOK	RSVD

- SHUTDOWNEN = Indicates the bq27421-G1 has received the SHUTDOWN_ENABLE subcommand and is enabled for SHUTDOWN. Active when set.
- WDRESET = Indicates the bq27421-G1 has performed a Watchdog Reset. Active when set.
- SS = Indicates the bq27421-G1 is in the SEALED State. Active when set.
- CALMODE = Indicates the bq27421-G1 is in calibration mode. Active when set.
- CCA = Indicates the bq27421-G1 Coulomb Counter Auto-Calibration routine is active. The CCA routine will take place approximately 3 minutes and 45 seconds after the initialization as well as periodically as conditions permit. Active when set.
- BCA = Indicates the bq27421-G1 board calibration routine is active. Active when set.
- QMAX_UP = Indicates Qmax has Updated. True when set. This bit is cleared after power on reset or when [BAT_DET] bit is set. When this bit is cleared, it enables fast learning of battery Qmax.
- RES_UP = Indicates that resistance has been updated. True when set. This bit is cleared after power on reset or when [BAT_DET] bit is set. Also this bit can only be set after Qmax is updated. ([QMAX_UP] set). When this bit is cleared, it enables fast learning of battery impedance.
- HIBERNATE = Indicates a request for entry into HIBERNATE from SLEEP mode has been issued. True when set.
- SLEEP = Indicates the bq27421-G1 is in SLEEP mode. True when set.
- LDMD = Indicates the algorithm is using constant-power mode. True when set. Default is 1.
- RUP_DIS = Indicates the bq27421-G1 Ra table updates are disabled. Updates are disabled when set.
- VOK = Indicates cell voltages are OK for Qmax updates. True when set.
- RSVD = Reserved.

4.1.2 DEVICE_TYPE: 0x0001

Instructs the fuel gauge to return the device type to addresses 0x00/0x01. The value returned is 0x0421.

4.1.3 FW_VERSION: 0x0002

Instructs the fuel gauge to return the firmware version to addresses 0x00/0x01.

4.1.4 DM_CODE: 0x0004

Instructs the fuel gauge to return the 8-bit **DM Code** as the least significant byte of the 16-bit return value at addresses 0x00 and 0x01. The DM_CODE subcommand provides a simple method to determine the configuration code stored in Data Memory.

4.1.5 **PREV_MACWRITE: 0x0007**

Instructs the fuel gauge to return the previous command written to addresses 0x00/0x01. The value returned is limited to less than 0x0015.

4.1.6 **CHEM_ID: 0x0008**

Instructs the fuel gauge to return the chemical identifier for the Impedance Track™ configuration to addresses 0x00/0x01. The expected value for bq27421-G1A is 0x0128 and for bq27421-G1B is 0x0312.

4.1.7 **BAT_INSERT: 0X000C**

This subcommand forces the *Flags()* [BAT_DET] bit to set when the battery insertion detection is disabled via **OpConfig**[BIE=0]. In this case, the gauge does not detect battery insertion from the BIN pin's logic state, but relies on the BAT_INSERT host subcommand to indicate battery presence in the system. This subcommand also starts Impedance Track™ gauging.

4.1.8 **BAT_REMOVE: 0X000D**

This subcommand forces the *Flags()* [BAT_DET] bit to clear when the battery insertion detection is disabled via **OpConfig**[BIE=0]. In this case, the gauge does not detect battery removal from the BIN pin's logic state, but relies on the BAT_REMOVE host subcommand to indicate battery removal from the system.

4.1.9 **SET_HIBERNATE: 0x0011**

Instructs the fuel gauge to force the CONTROL_STATUS[HIBERNATE] bit to 1. If the necessary conditions are met, this enables the gauge to enter the HIBERNATE power mode after the transition to SLEEP power state is detected. The [HIBERNATE] bit is automatically cleared upon exiting from HIBERNATE mode.

4.1.10 **CLEAR_HIBERNATE: 0x0012**

Instructs the fuel gauge to force the CONTROL_STATUS[HIBERNATE] bit to 0. This prevents the gauge from entering the HIBERNATE power mode after the transition to SLEEP power state is detected. It can also be used to force the gauge out of HIBERNATE mode.

4.1.11 **SET_CFGUPDATE: 0x0013**

Instructs the fuel gauge to set the *Flags*[CFGUPMODE] bit to 1 and enter CONFIG UPDATE mode. This command is only available when the fuel gauge is UNSEALED. Note: A SOFT_RESET subcommand is typically used to exit CONFIG UPDATE mode to resume normal gauging.

4.1.12 **SHUTDOWN_ENABLE: 0x001B**

Instructs the fuel gauge to enable SHUTDOWN mode and set the CONTROL_STATUS[SHUTDOWNEN] status bit.

4.1.13 **SHUTDOWN: 0x001C**

Instructs the fuel gauge to immediately enter SHUTDOWN mode after receiving this subcommand. The SHUTDOWN mode effectively a power down mode with only a small circuit biased by the BAT pin used to wake up detection. To enter SHUTDOWN mode, the SHUTDOWN_ENABLE command must have been previously received. The fuel gauge wakes up from SHUTDOWN mode upon detection of a low-to-high transition on the open-drain GPOUT pin.

4.1.14 SEALED: 0x0020

Instructs the fuel gauge to transition from UNSEALED state to SEALED state. The fuel gauge should always be set to SEALED state for use in end equipment.

4.1.15 PULSE_SOC_INT: 0x0023

This subcommand can be useful for system level debug or test purposes. It instructs the fuel gauge to pulse the GPOUT pin for approximately 1 ms within 1 second of receiving the command. Note: The GPOUT pin must be configured for the SOC_INT output function with **OpConfig[BATLOWEN]** cleared.

4.1.16 RESET : 0x0041

This command instructs the fuel gauge to perform a full device reset and reinitialize RAM data to the default values from ROM and is therefore not typically used in field operation. The gauge sets the *Flags[ITPOR]* bit and enters the INITIALIZE mode. Refer to [Figure 2-1](#). This command is only available when the fuel gauge is UNSEALED.

4.1.17 SOFT_RESET : 0x0042

This command instructs the fuel gauge to perform a partial (soft) reset from any mode with an OCV measurement. The *Flags[ITPOR, CFGUPMODE]* bits are cleared and a resimulation occurs to update *StateOfCharge()*. Refer to [Figure 2-1](#). This command is only available when the fuel gauge is UNSEALED.

4.2 Temperature(): 0x02/0x03

This read-/write-word function returns an unsigned integer value of the temperature in units of 0.1 K measured by the fuel gauge. If *OpConfig[TEMPS]* bit = 0 (default), a read command will return the internal temperature sensor value and write command will be ignored. If *OpConfig[TEMPS]* bit = 1, a write command sets the temperature to be used for gauging calculations while a read command returns to temperature previously written.

4.3 Voltage(): 0x04/0x05

This read-only function returns an unsigned integer value of the measured cell-pack voltage in mV with a range of 0 to 6000 mV.

4.4 Flags(): 0x06/0x07

This read-word function returns the contents of the fuel gauging status register, depicting the current operating status.

Table 4-4. Flags Bit Definitions

	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
High Byte	OT	UT	RSVD	RSVD	RSVD	RSVD	FC	CHG
Low Byte	OCVTAKEN	RSVD	ITPOR	CFGUPMODE	BAT_DET	SOC1	SOCF	DSG

- OT = Over-Temperature condition is detected. [OT] is set when *Temperature()* \geq **Over Temp** (default = 55 °C). [OT] is cleared when *Temperature()* $<$ **Over Temp - Temp Hys**.
- UT = Under-Temperature condition is detected. [UT] is set when *Temperature()* \leq **Under Temp** (default = 0 °C). [UT] is cleared when *Temperature()* $>$ **Under Temp + Temp Hys**.
- RSVD = Reserved. (High Byte bits 5:2)
- FC = Full-charge is detected. If the **FC Set%** (default =100%) is a positive threshold , [FC] is set when $SOC \geq$ **FC Set %** and is cleared when $SOC \leq$ **FC Clear %** (default = 98%). Alternatively, if **FC Set%** = -1, [FC] is set when the fuel gauge has detected charge termination.
- CHG = Fast charging allowed. If the **TCA Set%** (Terminate Charge Alarm Set %) is a positive threshold (default = 99%), [CHG] is cleared when $SOC \geq$ **TCA Set %** and is set when $SOC \leq$ **TCA Clear %** (default = 95%). Alternatively, if **TCA Set%** = -1, the TCA thresholds are disabled and the [CHG] bit is cleared when the fuel gauge has detected a taper condition.
- OCVTAKEN = Cleared on entry to relax mode and Set to 1 when OCV measurement is performed in relax
- RSVD = Reserved.
- ITPOR = Indicates a Power On Reset or RESET subcommand has occurred. If set, this bit generally indicates that the RAM configuration registers have been reset to default values and the host should reload the configuration parameters using the CONFIG UPDATE mode. This bit is cleared after the SOFT_RESET subcommand is received.
- CFGUPMODE = Fuel gauge is in CONFIG UPDATE mode. True when set. Default is 0. Refer to CONFIG UPDATE Mode section for details.
- BAT_DET = Battery insertion detected. True when set. When *OpConfig[BIE]* is set, [BAT_DET] is set by detecting a logic high to low transition at BIN pin. when *OpConfig[BIE]* is low, [BAT_DET] is set when host issues BAT_INSERT subcommand and clear when host issues BAT_REMOVE subcommand.
- SOC1 = If set, *StateOfCharge()* \leq **SOC1 Set Threshold**. The [SOC1] bit will remain set until *StateOfCharge()* \geq **SOC1 Clear Threshold**.
- SOCF = If set, *StateOfCharge()* \leq **SOCF Set Threshold**. The [SOCF] bit will remain set until *StateOfCharge()* \geq **SOCF Clear Threshold**.
- DSG = Discharging detected. True when set.

4.5 **NominalAvailableCapacity()**: 0x08/0x09

This read-only command pair returns the uncompensated (less than C/20 load) battery capacity remaining. Units are mAh.

4.6 **FullAvailableCapacity()**: 0x0a/0x0b

This read-only command pair returns the uncompensated (less than C/20 load) capacity of the battery when fully charged. Units are mAh. *FullAvailableCapacity()* is updated at regular intervals, as specified by the IT algorithm.

4.7 **RemainingCapacity()**: 0x0c/0x0d

This read-only command pair returns the compensated battery capacity remaining. Units are mAh.

4.8 **FullChargeCapacity()**: 0x0e/0f

This read-only command pair returns the compensated capacity of the battery when fully charged. Units are mAh. *FullChargeCapacity()* is updated at regular intervals, as specified by the IT algorithm.

4.9 **AverageCurrent()**: 0x10/0x11

This read-only command pair returns a signed integer value that is the average current flow through the sense resistor. In NORMAL mode, it is updated once per second and is calculated by dividing the 1 second change in coulomb counter data by 1 second. Large current spikes of short duration will be averaged out in this measurement. Units are mA.

4.10 **StandbyCurrent()**: 0x12/0x13

This read-only function returns a signed integer value of the measured standby current through the sense resistor. The *StandbyCurrent()* is an adaptive measurement. Initially it reports the standby current programmed in **Initial Standby**, and after spending several seconds in standby, reports the measured standby current.

The register value is updated every second when the measured current is above the **Deadband** and is less than or equal to $2 \times$ **Initial Standby**. The first and last values that meet this criteria are not averaged in, because they may not be stable values. To approximate a 1-minute time constant, each new *StandbyCurrent()* value is computed by taking approximately 93% weight of the last standby current and approximately 7% of the current measured average current.

4.11 **MaxLoadCurrent()**: 0x14/0x15

This read-only function returns a signed integer value, in units of mA, of the maximum load conditions. The *MaxLoadCurrent()* is an adaptive measurement which is initially reported as the maximum load current programmed in **Initial MaxLoad** current. If the measured current is ever greater than **Initial MaxLoad**, then *MaxLoadCurrent()* updates to the new current. *MaxLoadCurrent()* is reduced to the average of the previous value and **Initial MaxLoad** whenever the battery is charged to full after a previous discharge to an SOC less than 50%. This prevents the reported value from maintaining an unusually high value.

4.12 AveragePower(): 0x18/0x19

This read-only function returns a signed integer value of the average power during battery charging and discharging. It is negative during discharge and positive during charge. A value of 0 indicates that the battery is not being discharged. The value is reported in units of mW.

4.13 StateOfCharge(): 0x1c/0x1d

This read-only function returns an unsigned integer value of the predicted remaining battery capacity expressed as a percentage of *FullChargeCapacity()*, with a range of 0 to 100%.

4.14 IntTemperature(): 0x1e/0x1f

This read-only function returns an unsigned integer value of the internal temperature sensor in units of 0.1 K measured by the fuel gauge. If **OpConfig[TEMPS]** = 0, this command will return the same value as *Temperature()*.

4.15 StateOfHealth(): 0x20/0x21

0x20 SOH percentage: this read-only function returns an unsigned integer value, expressed as a percentage of the ratio of predicted FCC(25°C, **SOH LoadI**) over the *DesignCapacity()*. The FCC(25°C, **SOH LoadI**) is the calculated full charge capacity at 25°C and the **SOH LoadI** which is programmed in factory (default = -400mA). The range of the returned SOH percentage is 0x00 to 0x64, indicating 0 to 100% correspondingly.

0x21 SOH Status: this read-only function returns an unsigned integer value, indicating the status of the SOH percentage:

- 0x00: SOH not valid (initialization)
- 0x01: Instant SOH value ready
- 0x02: Initial SOH value ready
 - Calculation based on default Qmax
 - May not reflect SOH for currently inserted pack
- 0x03: SOH value ready
 - Calculation based on learned Qmax
 - Most accurate SOH for currently inserted pack following a Qmax update
- 0x04-0xFF: Reserved

EXTENDED DATA COMMANDS

Extended data commands offer additional functionality beyond the standard set of commands. They are used in the same manner; however unlike standard commands, extended commands are not limited to 2-byte words. The number of command bytes for a given extended command ranges in size from single to multiple bytes, as specified in [Table 5-1](#).

Table 5-1. Extended Commands

NAME	COMMAND CODE	UNITS	SEALED ACCESS ^{(1) (2)}	UNSEALED ACCESS ^{(1) (2)}
<i>OpConfig()</i>	0x3A/0x3B	N/A	R	R
<i>DesignCapacity()</i>	0x3C/0x3D	mAh	R	R
<i>DataClass()</i> ⁽²⁾	0x3E	N/A	N/A	R/W
<i>DataBlock()</i> ⁽²⁾	0x3F	N/A	R/W	R/W
<i>BlockData()</i>	0x40...0x5F	N/A	R	R/W
<i>BlockDataChecksum()</i>	0x60	N/A	R/W	R/W
<i>BlockDataControl()</i>	0x61	N/A	N/A	R/W
Reserved	0x62...0x7F	N/A	R	R

⁽¹⁾ SEALED and UNSEALED states are entered via commands to **Control()** 0x00/0x01

⁽²⁾ In sealed mode, data CANNOT be accessed through commands 0x3e and 0x3f.

5.1 OpConfig(): 0x3a/0x3b

SEALED and UNSEALED Access: This command returns the **OpConfig** Data Memory register setting which is most useful for system level debug to quickly determine device configuration.

5.2 DesignCapacity(): 0x3c/0x3d

SEALED and UNSEALED Access: This command returns the **Design Capacity** Data Memory value and is most useful for system level debug to quickly determine device configuration.

5.3 DataClass(): 0x3e

UNSEALED Access: This command sets the data class to be accessed. The class to be accessed should be entered in hexadecimal.

SEALED Access: This command is not available in SEALED mode.

5.4 DataBlock(): 0x3f

UNSEALED Access: This command sets the data block to be accessed. When 0x00 is written to **BlockDataControl()**, **DataBlock()** holds the block number of the data to be read or written. Example: writing a 0x00 to **DataBlock()** specifies access to the first 32 byte block and a 0x01 specifies access to the second 32 byte block, and so on.

SEALED Access: Issuing a 0x01 instructs the **BlockData()** command to transfer the **Manufacturer Info** block.

5.5 **BlockData()**: 0x40...0x5f

UNSEALED Access: This data block is the remainder of the 32 byte data block when accessing general block data.

5.6 **BlockDataChecksum()**: 0x60

UNSEALED Access: This byte contains the checksum on the 32 bytes of block data read or written. The least-significant byte of the sum of the data bytes written must be complemented ($[255 - x]$, for x the least-significant byte) before being written to 0x60. For a block write, the correct complemented checksum must be written before the *BlockData()* will be transferred to RAM.

SEALED Access: This byte contains the checksum for the 8 bytes of the **Manufacturer Info** block.

5.7 **BlockDataControl()**: 0x61

UNSEALED Access: This command is used to control the data access mode. Writing 0x00 to this command enables *BlockData()* to access to RAM.

SEALED Access: This command is not available in SEALED mode.

5.8 **Reserved – 0x62 – 0x7f**

DATA MEMORY

6.1 Data Memory Interface

6.1.1 Accessing the Data Memory

The fuel gauge's Data Memory contains initialization, default, cell status, calibration, configuration, and user information. Most Data Memory parameters reside in volatile RAM that are initialized by associated parameters from ROM. However, some Data Memory parameters are directly accessed from ROM and do not have an associated RAM copy. The Data Memory can be accessed in several different ways, depending on what mode the fuel gauge is operating in and what data is being accessed.

Commonly accessed Data Memory memory locations, frequently read by a system, are conveniently accessed through specific instructions, already described in [Chapter 5, Extended Data Commands](#). These commands are available when the fuel gauge is either in UNSEALED or SEALED modes.

Most Data Memory locations, however, are only accessible in UNSEALED mode by use of the evaluation software or by Data Memory block transfers. These locations should be optimized and/or fixed during the development and manufacturing processes. They become part of a golden image file and then can be written to multiple battery packs. Once established, the values generally remain unchanged during end-equipment operation.

To access Data Memory locations individually, the block containing the desired Data Memory location(s) must be transferred to the command register locations, where they can be read to the system or changed directly. This is accomplished by sending the set-up command *BlockDataControl()* (0x61) with data 0x00. Up to 32 bytes of data can be read directly from the *BlockData()* (0x40 through 0x5F), externally altered, then rewritten to the *BlockData()* command space. Alternatively, specific locations can be read, altered, and rewritten if their corresponding offsets index into the *BlockData()* command space. Finally, the data residing in the command space is transferred to Data Memory, once the correct checksum for the whole block is written to *BlockDataChecksum()* (0x60).

Occasionally, a Data Memory class is larger than the 32-byte block size. In this case, the *DataBlock()* command designates in which 32-byte block the desired locations reside. The correct command address is then given by $0x40 + \text{offset modulo } 32$. For an example of this type of Data Memory access, refer to [Section 3.1](#).

Reading and writing subclass data are block operations up to 32 bytes in length. During a write, if the data length exceeds the maximum block size, then the data is ignored.

None of the data written to memory are bounded by the fuel gauge — the values are not rejected by the fuel gauge. Writing an incorrect value may result in hardware failure due to firmware program interpretation of the invalid data. The written data is persistent, so a power-on reset does resolve the fault.

6.1.2 Access Modes

The fuel gauge provides two access modes, UNSEALED and SEALED, that control the Data Memory access permissions. The default access mode of the bq27421-G1 is UNSEALED, so the system processor must send a SEALED subcommand after a gauge reset in order to utilize the data protection feature.

6.1.3 SEALING and UNSEALING Data Memory Access

The fuel gauge implements a key-access scheme to transition from SEALED to UNSEALED mode. Once SEALED via the associated subcommand, a unique set of two keys must be sent to the fuel gauge via the *Control()* command to return to UNSEALED mode. The keys must be sent consecutively, with no other data being written to the *Control()* register in between.

When in the SEALED mode, the CONTROL_STATUS [SS] bit is set; but when the **Sealed to Unsealed** keys are correctly received by the fuel gauge, the [SS] bit is cleared. The **Sealed to Unsealed** key has two identical words stored in ROM with a value of 0x80008000. Then *Control()* should supply 0x8000 and 0x8000 (again) to unseal the part.

6.2 Data Types Summary

Table 6-1. Data Type Decoder

Type	Min Value	Max Value
I1	-128	127
I2	-32768	32767
I4	-2,147,483,648	2,147,483,647
U1	0	255
U2	0	65535
U4	0	4,294,967,295
H1	0x00	0xFF
H2	0x00	0xFFFF
H4	0x00	0xFFFF FFFF
Sx	1-byte string	X-byte string

6.3 Data Memory Summary Tables

Table 6-2. Data Memory Summary - Configuration

Subclass ID	Subclass	Offset	Name	Data Type	Min Value	Max Value	(-G1A/B) Default	Units (EVSW Units)*
2	Safety	0	Over Temp	I2	-1200	1200	550	0.1°C
		2	Under Temp	I2	-1200	1200	0	0.1°C
		4	Temp Hys	U1	0	255	50	s
36	Charge Termination	0	Min Taper Capacity	I2	0	1000	25	mAh
		2	Current Taper Window	U1	0	60	40	s
		3	TCA Set %	I1	-1	100	99	%
		4	TCA Clear %	I1	-1	100	95	%
		5	FC Set %	I1	-1	100	-1	%
		6	FC Clear %	I1	-1	100	98	%
		7	DODatEOC Delta T	I2	0	1000	50	0.1°C
48	Data	2	Initial Standby	I1	-256	0	-3	mA
		3	Initial MaxLoad	I2	-32767	0	-200	mA
49	Discharge	0	SOC1 Set Threshold	U1	0	255	10	%
		1	SOC1 Clear Threshold	U1	0	255	15	%
		2	SOCF Set Threshold	U1	0	255	2	%
		3	SOCF Clear Threshold	U1	0	255	5	%
64	Registers	0	OpConfig	H2	0x0000	0xFFFF	0x25F8	
		2	OpConfigB	H1	0x00	0xFF	0x0F	
		3	DM Code	U1	0	255	A = 0x00 B = 0x10	
68	Power	7	Hibernate I	I2	0	700	3	mA
		9	Hibernate V	I2	2400	3000	2200	mV
		11	FS Wait	U1	0	255	1	s

Table 6-3. Data Memory Summary - Gas (Fuel) Gauging

Subclass ID	Subclass	Offset	Name	Data Type	Min Value	Max Value	(-G1A/B) Default	Units (EVSW Units)*
80	IT Cfg	4	Sec. Relax Time	U2	0	65535	30	s
		10	Average Time	U1	0	255	8	
		17	Min DOD Res Update	U1	0	255	70	%
		19	Max Res Factor	U1	0	255	20	
		20	Min Res Factor	U1	0	255	5	
		22	Ra Filter	U2	0	1000	800	
		28	Max V Delta	U1	0	255	10	
		35	Fast Qmax Start DOD %	U1	0	255	92	%
		36	Fast Qmax End DOD %	U1	0	255	96	%
		37	Fast Qmax Start Volt Delta	I2	0	4200	125	mV
		39	Fast Qmax Current Threshold	I2	0	1000	4	.1 Hr rate
		41	Fast Qmax Min Points	U1	0	255	3	
		42	Fast Qmax Volt Buffer	U1	0	255	25	mV
		44	Qmax Capacity Err	U1	0	100	15	0.1%
		45	Max Qmax Change	U1	0	255	20	%
		48	ResRelax Time	U2	0	65534	500	s
		52	User Rate-mW	I2	-14000	-3000	0	cW
		54	Reserve Cap-mWh	I2	0	14000	0	10mW
		59	Max Sim Rate	U1	0	255	1	Hr rate
		60	Min Sim Rate	U1	0	255	20	Hr rate
		61	Ra Max Delta	U2	0	100	11	mOhm
		70	Min Delta Voltage	I2	-32000	32000	0	
		72	Max Delta Voltage	I2	-32000	32000	200	
74	DeltaV Max dV	I2	0	32000	100	mV		
76	TermV Valid t	U1	0	255	2	sec		

Table 6-3. Data Memory Summary - Gas (Fuel) Gauging (continued)

Subclass ID	Subclass	Offset	Name	Data Type	Min Value	Max Value	(-G1A/B) Default	Units (EVSU Units)*		
81	Current Thresholds	0	Dsg Current Threshold	I2	0	2000	167	mA		
		2	Chg Current Threshold	I2	0	2000	100	mA		
		4	Quit Current	I2	0	1000	250	mA		
		6	Dsg Relax Time	U2	0	8191	60	s		
		8	Chg Relax Time	U1	0	255	60	s		
		9	Quit Relax Time	U1	0	63	1	s		
		10	Transient Factor Charge	U1	0	255	179			
		11	Transient Factor Discharge	U1	0	255	179			
		12	Max IR Correct	U2	0	1000	400	mV		
		82	State	0	Qmax Cell 0	I2	0	32767	16384	mAh
				2	Update Status	H1	0x00	0x36	0x00	
				3	Reserve Cap-mAh	I2	0	9000	0	mA
5	Load Select/Mode			H1	0x00	0xFF	0x81			
6	Q Invalid Max V			I2	0	32767	A = 3803 B = 3814	mV		
8	Q Invalid Min V			I2	0	32767	A = 3752 B = 3748	mV		
10	Design Capacity			I2	0	32767	A = 1340 B = 1000	mA		
12	Design Energy			I2	0	32767	A = 4960 B = 3700	mWh		
14	Default Design Cap			I2	0	32767	A = 1340 B = 5580	mWh		
16	Terminate Voltage			I2	2800	3700	3200	mV		
26	SOCI Delta			U1	0	100	1	%		
27	Taper Rate			I2	0	2000	100	.1 Hr rate		
29	Taper Voltage			I2	0	5000	A = 4100 B = 4200	mV		
31	Sleep Current			I2	0	100	10	mA		
33	V at Chg Term			I2	0	5000	A = 4190 B = 4290	mV		
35	Avg I Last Run			I2	-32768	32767	-50	mA		
37	Avg P Last Run			I2	-32768	32767	-50	mW		
39	Delta Voltage			I2	-32768	32767	1	mV		

Table 6-4. Data Memory Summary - Resistance Tables

Subclass ID	Subclass	Offset	Name	Data Type	Min Value	Max Value	Default Value	Units (EVSW Units)*
88	R_a NVM	0 - 28	Cell0 R_a 0 - 14	I2				2 ⁻¹⁰ Ω
89	R_a RAM	0 - 28	Cell0 R_a 0 - 14	I2				2 ⁻¹⁰ Ω

Table 6-5. Data Memory Summary - Calibration and Security

Subclass ID	Subclass	Offset	Name	Data Type	Min Value	Max Value	Default Value	Units (EVSW Units)*
104	Data	0	Board Offset	I1	-128	127	0	
		1	Int Temp Offset	I1	-128	127	0	
		2	Pack V Offset	I1	-128	127	0	
105	CC Cal	0	CC Offset	I2	-32768	32767	-1200	
		2	CC Cal Temp	I2	0	32767	2982	0.1K
		4	CC Gain	F4	1.0e-1	4.0e+1	0.47095	
		8	CC Delta	F4	2.9826e+4	1.193046e+6	559538.8	
107	Current	1	Deadband	U1	0	255	5	mA
		19	RDL Tempco	F4	1.0e-20	4.0e+1	0.000393	
112	Codes	0	Sealed to Unsealed	H4	0x0000/ 0x0000	0xFFFF/ 0xFFFF	0x8000/ 0x8000	-

6.4 Data Memory Parameter Descriptions

6.4.1 Configuration Class

6.4.1.1 Safety Subclass 2

6.4.1.1.1 Over Temp, Under Temp, Temp Hys

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
2	Safety	Over Temp	I2	-1200	1200	550	0.1°C
		Under Temp	I2	-1200	1200	0	0.1°C
		Temp Hys	U1	0	255	50	0.1°C

An Over-Temperature condition is detected if $Temperature() \geq \text{Over Temp}$ (default = 55 °C) and indicated by setting the $Flags()$ [OT] bit. The [OT] bit is cleared when $Temperature() < \text{Over Temp} - \text{Temp Hys}$ (default = 50 °C).

An Under-Temperature condition is detected if $Temperature() \leq \text{Under Temp}$ (default = 0 °C) and indicated by setting the $Flags()$ [UT] bit. The [UT] bit is cleared when $Temperature() > \text{Under Temp} + \text{Temp Hys}$ (default = 5 °C).

6.4.1.2 Charge Termination Subclass 36

6.4.1.2.1 Min Taper Capacity, Current Taper Window

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
36	Charge Termination	Min Taper Capacity	I2	0	1000	25	mAh
		Current Taper Window	U1	0	60	40	s

Refer to description of **Taper Rate** and **Taper Voltage** for details on **Min Taper Capacity** and **Current Taper Window**. See [Section 6.4.2.3.9](#).

6.4.1.2.2 Terminate Charge Alarm Set % (TCA Set %), Terminate Charge Alarm Clear % (TCA Clear %)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
36	Charge Termination	TCA Set %	I1	-1%	100%	99%	
		TCA Clear %	I1	-1%	100%	95%	

The $Flags()$ [CHG] bit is set when SOC reaches **TCA Set** and is cleared when it drops below **TCA Clear**.

The $Flags()$ [CHG] bit is set when Primary Charge Termination conditions are met and **TCA Set** is set to -1%.

6.4.1.2.3 Full Charge Set % (FC Set %), Full Charge Clear % (FC Clear %)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
36	Charge Termination	FC Set %	I1	-1%	100%	100%	
		FC Clear %	I1	-1%	100%	98%	

The *Flags()* [FC] bit is set when SOC reaches **FC Set** and is cleared when it drops below **FC Clear**.

The *Flags()* [FC] bit is set when Primary Charge Termination conditions are met and **FC Set** is set to -1%.

6.4.1.2.4 DOD at EOC Delta Temperature

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
36	Charge Termination	DODatEOC Delta T	I2	0	1000	100	0.1°C

During relaxation and charge start, **REMCAP** = *FullChargeCapacity()* - *Qstart()*. But with temperature decreases, *Qstart()* can become much smaller than old *FullChargeCapacity()* resulting in over-estimation of **REMCAP**. To improve accuracy, *FullChargeCapacity()* is updated when temperature change from previous *FullChargeCapacity()* update is more than **DODatEOC Delta T**.

6.4.1.3 Data Subclass 48

6.4.1.3.1 Initial Standby Current

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
48	Data	Initial Standby	I1	-256	0	-3	mA

This is the initial value that is reported in *StandbyCurrent()*. The *StandbyCurrent()* value is updated every 1 second when the measured current meets the following criteria:
|Current| > **Deadband** and Current ≤ 2 × **Initial Standby**.

Note: Current is negative during discharge.

This value depends on the system. The initial standby current is the current load drawn by the system when in low-power mode.

6.4.1.3.2 Initial Maximum Load Current

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
48	Data	Initial MaxLoad	I2	-32767	0	-200	mA

This is the initial value that is reported in *MaxLoadCurrent()*. The *MaxLoadCurrent()* is updated to the new current when Current > **Initial MaxLoad**. *MaxLoadCurrent()* is reduced to the average of the previous value and **Initial MaxLoad** whenever the battery is charged to full after a previous discharge to an SOC less than 50%. This prevents the reported value from maintaining an unusually high value. Default value depends on the system.

6.4.1.4 Discharge Subclass 49

6.4.1.4.1 State of Charge 1 Set or Clear Threshold (SOC1 Set Threshold, SOC1 Clear Threshold)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
49	Discharge	SOC1 Set Threshold	U1	0	255	10	%
		SOC1 Clear Threshold	U1	0	255	15	%

When *RemainingCapacity()* falls to or below the first capacity threshold, specified in **SOC1 Set Threshold**, the *Flags()* [SOC1] bit is set. This bit is cleared once *RemainingCapacity()* rises to or above **SOC1 Clear Threshold**.

These values are user preference.

6.4.1.4.2 State of Charge Final Set or Clear Threshold (SOCF Set Threshold, SOCF Clear Threshold)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
49	Discharge	SOCF Set Threshold	U1	0	255	2	%
		SOCF Clear Threshold	U1	0	255	5	%

When *RemainingCapacity()* falls to or below the final capacity threshold, specified in **SOCF Set Threshold**, the *Flags()* [SOCF] bit is set. This bit is cleared once *RemainingCapacity()* rises to or above **SOCF Clear Threshold**. The [SOCF] bit serves as the final discharge warning.

These values are user preference.

6.4.1.5 Registers Subclass 64

6.4.1.5.1 OpConfig

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
64	Registers	OpConfig	H2	0x0000	0xFFFF	0x25F8	hex

Table 6-6. Op Config Register Definition

	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
High Byte	RSVD0	RSVD0	BIE	BI_PU_EN	GPIOPOL	RSVD1	RSVD0	RSVD1
Default =	0	0	1	0	0	1	0	1
0x25								
Low Byte	RSVD1	RSVD1	SLEEP	RMFCC	RSVD1	BATLOWEN	RSVD0	TEMPS
Default =	1	1	1	1	1	0	0	0
0xF8								

BIE = Battery Insertion Enable. If set, the battery insertion is detection via BIN pin input. If cleared, the detection relies on the host to issue BAT_INSERT subcommand to indicate battery presence in the system.

BI_PU_EN = Enables internal weak pull-up on BIN pin. True when set. If false, an external pull-up resistor is expected.

GPIOPOL = GPOUT pin is active-high if set or active-low if cleared.

SLEEP = The fuel gauge can enter sleep, if operating conditions allow. True when set.

RMFCC = RM is updated with the value from FCC on valid charge termination. True when set.

BATLOWEN = If set, the BAT_LOW function for GPOUT pin is selected. If cleared, the SOC_INT function is selected for GPOUT.

TEMPS = Selects the temperature source. Enables the host to write *Temperature()* if set. If cleared, the internal temperature sensor is used for *Temperature()*.

RSVD0 = Reserved. Default is 0. (Set to 0 for proper operation)

RSVD1 = Reserved. Default is 1. (Set to 1 for proper operation)

6.4.1.5.2 OpConfigB

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
64	Registers	OpConfigB	H1	0x00	0xFF	0x0F	hex

Table 6-7. Op ConfigB Register Definition

	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
	RSVD0	RSVD0	RSVD0	RSVD0	RSVD1	SMOOTHEN	RSVD1	RSVD1
Default =	0	0	0	0	1	1	1	1
0x0F								

SMOOTHEN = Enables the SOC smoothing feature. True when set.

RSVD0 = Reserved. Default is 0. (Set to 0 for proper operation)

RSVD1 = Reserved. Default is 1. (Set to 1 for proper operation)

6.4.1.5.3 DM Code

Subclass ID	Subclass	Name	Type	Min	Max	(-G1A/B) Default	Unit
64	Registers	DM Code	H1	0x00	0xFF	A = 0x00 B = 0x10	hex

This register contains the value to be returned by the DM_CODE subcommand. In addition to the CHEMID subcommand, the DM_CODE subcommand can be used to distinguish bq27421-G1 A and bq27421-G1B device.

6.4.1.6 Power Subclass 68

6.4.1.6.1 Hibernate Current

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
68	Power	Hibernate I	U2	0	700	8	mA

When $|AverageCurrent()| < \text{Hibernate } I$, the gauge enters HIBERNATE mode if CONTROL_STATUS [HIBERNATE] bit is set and cell is relaxed. This setting should be below any normal application currents.

6.4.1.6.2 Hibernate Voltage

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
68	Power	Hibernate V	U2	2400	3000	2550	mV

When $|Voltage| < \text{Hibernate } V$, the gauge enters HIBERNATE mode. The CONTROL_STATUS [HIBERNATE] bit has no impact for the gauge to enter HIBERNATE mode. This setting should be below any normal application voltage.

6.4.1.6.3 Full Sleep Wait Time

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
68	Power	FS Wait	U1	0	255	1	s

FULLSLEEP mode can be entered by setting the **FS Wait** to a number larger than 0. The FULLSLEEP mode is entered when the timer counts down to 0.

This value is set to 0 to disable the **FS Wait** function.

6.4.2 Gas (Fuel) Gauging Class

6.4.2.1 IT Cfg Subclass 80

6.4.2.1.1 Sample Secondary Relax Time

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Sec. Relax Time	U2	0	65535	30	s

Sec. Relax Time sets the measurement frequency of the Ra values that calculate the Ra grid point value. At the same time, it also sets the frequency of Fast Ra Scaling calculation.

6.4.2.1.2 Average Time (Sample Average Relax Time)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Average Time	U1	0	255	8	Count s

Sample **Average Time** specifies time used for voltage, temperature, and current averages used for resistance calculation.

6.4.2.1.3 Minimum DOD Resistance Update

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Min DOD Res Update	U1	0%	255%	70%	

Min DOD Res Update specifies the delta DOD between 2 grid points. Resistance measurements are not used for the next grid calculation if they were made below **Min DOD Res Update**.

6.4.2.1.4 Maximum and Minimum Resistance Factors

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Max Res Factor	U1	0	255	20	—
		Min Res Factor	U1	0	255	5	—

The **Max Res Factor** and **Min Res Factor** parameters are cumulative filters which limit the change in Ra values to a scale on a per discharge cycle basis.

For $Ra_{new} > Ra_{old}$,
 New Ra = $\min(Ra_{new}, Ra_{old} \times \mathbf{Max\ Res\ Factor} \div 10)$

For $Ra_{new} < Ra_{old}$,
 New Ra = $\max(Ra_{new}, Ra_{old} \times \mathbf{Min\ Res\ Factor} \div 10)$

6.4.2.1.5 Ra Filter

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Ra Filter	U2	0	1000	800	—

Ra Filter is a filter constant used to calculate the filtered Ra value that is stored into Data Memory from the old Ra value.

$$Ra = (Ra_{old} \times Ra\ Filter + Ra_{new} \times (1000 - Ra\ Filter)) \div 1000$$

6.4.2.1.6 Max V Delta

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Max V Delta	U1	0	255	10	mV

Max V Delta specifies dV/dt condition for Qmax qualification in Relax mode. Value of 10 corresponds to 1 μ V/s.

6.4.2.1.7 Fast Qmax Start DOD%, Fast Qmax Start Voltage Delta, Fast Qmax Current Threshold

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Fast Qmax Start DOD%	U1	0	255	92	%
		Fast Qmax Start Volt Delta	I2	0	4200	125	mV
		Fast Qmax Current Threshold	I2	0	1000	4	0.1 Hr rate

Fast Qmax measurement starts when the following conditions are met,

- DOD > **Fast Qmax Start DOD%** or
Voltage < **Terminate Voltage + Fast Qmax Start Volt Delta**
- Current < C / **Fast Qmax Current Threshold**

6.4.2.1.8 Fast Qmax End DOD%, Fast Qmax Minimum Data Points, Fast Qmax Update Voltage Buffer

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Fast Qmax End DOD%	U1	0	255	96	%
		Fast Qmax Min Points	U1	0	255	3	—
		Fast Qmax Volt Buffer	U1	0	255	25	mV

Fast Qmax measurement is calculated at the end of discharge when the following conditions are met:

- Number of Fast Qmax measurements > **Fast Qmax Min Points**
- DOD > **Fast Qmax End DOD%** or
Voltage < **Terminate Voltage + Fast Qmax Volt Buffer**

6.4.2.1.9 Qmax Capacity Error

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Qmax Capacity Err	U1	0	100	15	0.1%

Qmax Capacity Err specifies maximum capacity error allowed during Qmax update. Capacity error is estimated based on the time spent for Qmax measurement.

6.4.2.1.10 Maximum Qmax Change

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Max Qmax Change	U1	0	255	30	%

Max Qmax Change specifies maximum allowed change in Qmax value during Qmax update. Qmax update is disqualified if change from previous Qmax value is greater than **Max Qmax Change**.

6.4.2.1.11 Simulation Res Relax Time (ResRelax Time)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	ResRelax Time	U2	0	65534	500	s

This value is used for Impedance Track™ transient modeling of effective resistance. The resistance increases from zero to final value determined by the Ra table as defined by the exponent with time constant **Res Relax Time** during discharge simulation. Default value has been optimized for typical cell behavior.

6.4.2.1.12 User Rate-Pwr

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	User Rate-Pwr	I2	-14000	-3000	0	cW

This is the discharge rate in mW used for Impedance Track™ simulation of voltage profile to determine discharge capacity. It is only used when **Load Mode** = 1 (constant-power) and **Load Select** = 6 (user-defined rate).

6.4.2.1.13 Reserve Energy (Reserve Cap-mWh)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Reserve Energy	I2	0	14000	0	cWh

Reserve Cap-mWh determines how much actual remaining capacity exists after reaching 0 *RemainingCapacity()* before **Terminate Voltage** is reached. This register is only used if **Load Mode** = 1 (constant-power). A no-load rate of compensation is applied to this reserve capacity. This is a specialized function to allow time for a controlled shutdown after 0 *RemainingCapacity()* is reached.

6.4.2.1.14 Max Simulation Rate, Min Simulation Rate

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Max Sim Rate	U1	0	255	1	Hr rate
		Min Sim Rate	U1	0	255	20	Hr rate

Maximum and minimum limits for current used in simulation runs. The parameters are functions of *DesignCapacity()* (that is, *C/Max Sim Rate* or *C/Min Sim Rate*).

6.4.2.1.15 Ra Max Delta

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Ra Max Delta	U2	0	100	11	mΩ

During the update of Ra values a filtering process is performed to eliminate unexpected fluctuations in the updated Ra values. **Ra Max Delta** limits the change in Ra values to an absolute magnitude per Ra update.

6.4.2.2 Current Thresholds Subclass 81

6.4.2.2.1 Discharge Detection Threshold

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
81	Current Thresholds	Dsg Current Threshold	I2	0	2000	167	mA

This register is used as a threshold in the gauge to determine if actual discharge current is flowing out of the battery. This is independent of the *Flags()* [DSG] bit, which indicates whether the gauge is in discharge mode or charge mode. If the gauge is charging, then the [DSG] bit is 0 and any other time, the [DSG] bit is set to 1. Impedance Track™ algorithm in the gauge requires more definitive information about whether current is flowing in either the charge or discharge direction. **Dsg Current Threshold** is used for this purpose. This default threshold should be sufficient for most applications. This threshold should be set low enough to be below any normal application load current but high enough to prevent noise or drift from affecting the measurement.

6.4.2.2.2 Charge Detection Threshold

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
81	Current Thresholds	Chg Current Threshold	I2	0	2000	100	mA

This register is used as a threshold in the gauge to determine if actual charge current is flowing into the battery. This is independent of the *Flags()* [DSG] bit, which indicates whether the gauge is in discharge mode or charge mode. If the gauge is charging, then the [DSG] bit is 0 and any other time, the [DSG] bit is set to 1. Impedance Track™ algorithm in the gauge requires more definitive information about whether current is flowing in either the charge or discharge direction. **Chg Current Threshold** is used for this purpose. This default threshold should be sufficient for most applications. This threshold should be set low enough to be below any normal charge current but high enough to prevent noise or drift from affecting the measurement.

6.4.2.2.3 Quit Current, Discharge Relax Time, Charge Relax Time

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
81	Current Thresholds	Quit Current	I2	0	1000	40	mA
		Dsg Relax Time	U2	0	8191	60	s
		Chg Relax Time	U1	0	255	60	s

The **Quit Current** is used as part of the Impedance Track™ algorithm to determine when the fuel gauge enters relaxation mode from a current flowing mode in either the charge direction or the discharge direction. The value of **Quit Current** is set to a default value that should be above the standby current of the system. Either of the following criteria must be met to enter relaxation mode:

- $|AverageCurrent()| < |Quit Current|$ for **Dsg Relax Time**
- $|AverageCurrent()| > |Quit Current|$ for **Chg Relax Time**

After about 6 minutes in relaxation mode, the fuel gauge attempts to take accurate OCV readings. An additional requirement of $dV/dt < 2 \mu V/s$ is required for the fuel gauge to perform Qmax updates. These updates are used in the Impedance Track™ algorithms. It is critical that the battery voltage be relaxed during OCV readings and that the current is not higher than C/20 when attempting to go into relaxation mode.

The **Quit Current** is used as part of the Impedance Track™ algorithm to determine when the gauge goes into relaxation mode from a current-flowing mode in either the charge direction or the discharge direction. Either of the following criteria must be met to enter relaxation mode:

- $AverageCurrent()$ is greater than $(-)|Quit Current|$ and then goes within $(\pm)|Quit Current|$ for **Dsg Relax Time**.
- $AverageCurrent()$ is less than $|Quit Current|$ and then goes within $(\pm)|Quit Current|$ for **Chg Relax Time**.

After 30 minutes in relaxation mode, the gauge starts checking if the $dV/dt < 4 \mu V/s$ requirement for OCV readings is satisfied. When the battery relaxes sufficiently to satisfy this criteria, the gauge takes an OCV reading for updating Qmax and for accounting for self-discharge. These updates are used in the Impedance Track™ algorithms.

It is critical that the battery voltage is relaxed during OCV readings to get the most accurate results. This current must not be higher than C/20 when attempting to go into relaxation mode; however, it should not be too low as to prevent going into relaxation mode due to noise. This should always be less than **Chg Current Threshold** or **Dsg Current Threshold**.

6.4.2.2.4 Quit Relax Time

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
81	Current Thresholds	Quit Relax Time	U1	0	63	1	s

The **Quit Relax Time** is a delay time to exit relaxation. If current is great than **Chg Current Threshold** or less than **Dsg Current Threshold** and this condition is maintained during **Quit Relax Time**, then exiting relaxation is permitted.

This setting is particular to handheld applications in which low duty cycle dynamic loads are possible.

6.4.2.2.5 Transient Factor Charge, Transient Factor Discharge

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
81	Current Thresholds	Transient Factor Charge	U1	0	255	179	
		Transient Factor Discharge	U1	0	255	179	

The **Transient Factor Charge** and **Transient Factor Discharge** parameters provide an adjustment of the computed resistance due to transient voltage readings upon pack insertion for either charge or discharge conditions. The values range from 0 to 255 (default 179) and used as a scaling factor / 256 to adjust resistance such that $R_{adj} = R * \text{Transient_Factor} / 256$.

6.4.2.2.6 Max IR Correct

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
81	Current Thresholds	Max IR Correct	U2	0	1000	400	mV

The **Max IR Correct** is a maximum IR correction applied to OCV lookup under load. It only applies to OCV lookup after wakeup with detected charge current when gauge needs to establish capacity baseline, but the current is already flowing.

6.4.2.3 State Subclass 82

6.4.2.3.1 Qmax Cell 0

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
82	State	Qmax Cell 0	I2	0	32767	1000	mAh

Qmax contains the maximum chemical capacity of the cell, and is determined by comparing states of charge before and after applying the load with the amount of charge passed. It corresponds to capacity at low rate (~C/20) of discharge. For high accuracy, this value is periodically updated by the gauge during operation. The Impedance Track™ algorithm updates this value and maintains it.

6.4.2.3.2 Update Status

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
82	State	Update Status	H1	0x0	0x6	0x0	hex

Bit 0 (0x01) of the **Update Status** register indicates that the gauge has learned new Qmax parameters and is accurate. The remaining bits are reserved. Bit 0 is updated as needed by the Impedance Track™ algorithm and should never be modified.

6.4.2.3.3 Reserve Capacity (Reserve Cap-mAh)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
82	State	Reserve Cap-mAh	I2	0	9000	0	mAh

Reserve Cap-mAh determines how much actual remaining capacity exists after reaching 0 *RemainingCapacity*() before **Terminate Voltage** is reached. This register is only used if **Load Mode** = 0 (constant-current). A no-load rate of compensation is applied to this reserve capacity. This is a specialized function to allow time for a controlled shutdown after 0 *RemainingCapacity*() is reached.

6.4.2.3.4 Load Select/Mode

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
80	IT Cfg	Load Select/Mode	H1	0x00	0xFF	0x81	—

Load Mode configures the fuel gauge to use either a constant-current or constant-power model for the Impedance Track™ algorithm as. When **Load Mode** is 0, the Constant Current Model is used. When 1 (default), the Constant Power Model is used. The CONTROL_STATUS [LDMD] bit reflects the status of **Load Mode**.

Load Select is used in conjunction with **Load Mode** to define the type of load model that computes the load-compensated capacity in the Impedance Track™ algorithm.

If **Load Mode** = 0 (Constant current), then the following options are available:

Table 6-8. Load Select/Mode parameter encoding

	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
	Load Mode	RSVD	RSVD	RSVD	RSVD	Load Select[2:0]		
Default =	1	0	0	0	0	0	0	1
	0x81							

Load Mode = Bit 7 contains the value for **Load Mode**. Refer to tables below for operational details.

RSVD = Reserved. Set to 0 for proper operation.

Load Select[2:0] = Bits 2:0 contain the value for **Load Select**. Refer to tables below for operational details. Default is 1.

Table 6-9. Current Model Used When Load Mode = 0

Load Select Value	Current Model Used
0	Average discharge current from previous cycle: There is an internal register that records the average discharge current through each entire discharge cycle. The previous average is stored in this register.
1 (default)	Present average discharge current: This is the average discharge current from the beginning of this discharge cycle until present time.
2	Average current: based off the <i>AverageCurrent()</i>
3	Current: based off of a low-pass-filtered version of <i>AverageCurrent()</i> ($\tau = 14$ s)
4	Design capacity / 5: C Rate based off of Design Capacity / 5 or a C / 5 rate in mA.
All others	Reserved

If **Load Mode** = 1 (Constant power) then the following options are available:

Table 6-10. Current Model Used When Load Mode = 1

Load Select Value	Power Model Used
0	Average discharge power from previous cycle: There is an internal register that records the average discharge power through each entire discharge cycle. The previous average is stored in this register.
1 (default)	Present average discharge power: This is the average discharge power from the beginning of this discharge cycle until present time.
2	Average current × voltage: based off the <i>AverageCurrent()</i> and <i>Voltage()</i> .
3	Current × voltage: based off of a low-pass-filtered version of <i>AverageCurrent()</i> ($\tau = 14$ s) and <i>Voltage()</i>
4	Design energy / 5: C Rate based off of Design Energy / 5 or a C / 5 rate in mA .
5	Reserved
6	User_Rate-mW: Use the value in User Rate-mW . This provides a user-configurable load model.
All others	Reserved

6.4.2.3.5 Q Invalid Maximum and Minimum Voltage

Subclass ID	Subclass	Name	Type	Min	Max	(-G1A/B) Default	Unit
82	State	Q Invalid MaxV	I2	0	32767	A = 3803 B = 3814	mV
		Q Invalid MinV	I2	0	32767	A = 3752 B = 3748	mV

Q Invalid Max V and **Q Invalid Min V** specify the Qmax disqualification voltage region generally known as the "flat region" of the OCV vs DOD curve. OCV measurement for Qmax calculation is disallowed in this region.

6.4.2.3.6 Design Capacity, Design Energy, Default Design Cap

Subclass ID	Subclass	Name	Type	Min	Max	(-G1A/B) Default	Unit
82	State	Design Capacity	I2	0	32767	A = 1340 B = 1000	mAh
		Design Energy	I2	0	32767	A = 4960 B = 3700	mWh
		Default Design Cap	I2	0	32767	A = 1340 B = 5580	mAh

Design Capacity is used for compensated battery capacity remaining and capacity when fully charged calculations are done by the gauge. It is also used for constant-current model for Impedance Track™ algorithm when **Load Mode** is 0 (constant-current) and **Load Select** is 4 (**Design Capacity** / 5 for constant discharge). The CONTROL_STATUS [LDMD] bit indicates Impedance Track™ algorithm using constant-current model when cleared.

Design Energy is used for compensated battery capacity remaining and capacity when fully charged calculations are done by the gauge. It is also used for constant-power model for Impedance Track™ algorithm when **Load Mode** is 1 (constant-power) and **Load Select** is 4 (**Design Energy** / 5 for constant discharge). The CONTROL_STATUS [LDMD] bit indicates Impedance Track™ algorithm using constant-power model when set.

These values should be set based on the battery specification. See the data sheet from the battery manufacturer.

Default Design Cap contains the capacity of the pack originally used to generate the CHEMID data and is used along with **Design Capacity** or **Design Energy** to scale data for the Impedance Track™ algorithm. **Default Design Cap** should not require modification for any specific application.

6.4.2.3.7 Terminate Voltage

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
82	State	Terminate Voltage	I2	2800	3700	3200	mV

Terminate Voltage is used in the Impedance Track™ algorithm to compute *RemainingCapacity()*. This is the absolute minimum voltage for end of discharge, where the remaining chemical capacity is assumed to be zero.

This register is application dependent. It should be set based on battery cell specification to prevent damage to the cells or the absolute minimum system input voltage, taking into account impedance drop from the PCB traces, FETs, and wires.

6.4.2.3.8 SOCI Delta

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
82	State	SOCI Delta	U1	0	100	1	%

The **SOCI Delta** parameter is active when the SOC_INT function is activated when **OpConfig[BATLOWEN]** is cleared. In this case, the GPOUT pin generates interrupts with ~1ms pulse width under various conditions as described in [Table 2-1](#).

6.4.2.3.9 Taper Rate, Taper Voltage

Subclass ID	Subclass	Name	Type	Min	Max	(-G1A/B) Default	Unit
82	State	Taper Rate	I2	0	2000	A/B = 100	.1 Hr rate
		Taper Voltage	I2	0	5000	A = 4100 B = 4200	mV

Taper Rate is used in the Primary Charge Termination Algorithm. *AverageCurrent()* is integrated over each of the two **Current Taper Window** periods separately and averaged separately to determine two averages (IRateAvg1, IRateAvg2).

The **Taper Voltage** threshold defines the minimum voltage necessary for as a qualifier for detection of charge termination.

Three requirements must be met to qualify for Primary Charge Termination:

- During two consecutive periods of **Current Taper Windows**:
IRateAvg1 < **Taper Rate** and IRateAvg2 < **Taper Rate**
- During the same periods: Accumulated change in capacity < **Min Taper Capacity** per **Current Taper Window**
- *Voltage()* > **Taper Voltage**

When Primary Charge Termination conditions are met, the *Flags()* [FC] bit is set and [CHG] bit is cleared. Also, if the **OpConfig [RMFCC]** bit is set, then *RemainingCapacity()* is set equal to *FullChargeCapacity()*.

6.4.2.3.10 Sleep Current

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
82	State	Sleep Current	I2	0	100	10	mA

When *AverageCurrent()* is less than **Sleep Current** or greater than $(-)$ **Sleep Current**, the gauge enters SLEEP mode if the feature is enable by setting the **OpConf [SLEEP]** bit.

This setting should be below any normal application currents.

6.4.2.3.11 Voltage at Charge Termination (V at Chg Term)

Subclass ID	Subclass	Name	Type	Min	Max	(-G1A/B) Default	Unit
82	State	V at Chg Term	I2	0	5000	A = 4190 B = 4290	mV

V at Chg Term is a learned Data Memory parameter as the voltage reading at the full charge taper termination. This voltage is used to calculate DODatEOC.

6.4.2.3.12 Average Current Last Run (Avg I Last Run)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
82	State	Avg I Last Run	I2	-32768	32767	-50	mA

The gauge logs the current averaged from the beginning to the end of each discharge cycle. It stores this average current from the previous discharge cycle in this register. This register should never need to be modified. It is only updated by the gauge when required.

6.4.2.3.13 Average Power Last Run (Avg P Last Run)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
82	State	Avg P Last Run	I2	-32768	32767	-50	mW

The gauge logs the power averaged from the beginning to the end of each discharge cycle. It stores this average power from the previous discharge cycle in this register. To get a correct average power reading the gauge continuously multiplies instantaneous current times voltage to get power. It then logs this data to derive the average power. This register should never need to be modified. It is only updated by the gauge when required.

6.4.2.3.14 Pulse Delta Voltage

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
82	State	Delta Voltage	I2	-32768	32767	1	mV

The gauge stores the maximum difference of Voltage during short load spikes and normal load, so the Impedance Track™ algorithm can calculate *RemainingCapacity()* for pulsed loads. It is added to **Terminate Voltage** for Impedance Track™ simulations.

6.4.3 Ra Table Class

6.4.3.1 R_a NVM Subclass 88, R_a RAM Subclass 89

6.4.3.1.1 Cell0 R_a NVM Table

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
88	R_a ROM	Cell0 R_a 0 - 14	I2	–	–	–	$2^{-10} \Omega$
89	R_a RAM	Cell0 R_a 0 - 14	I2	–	–	–	$2^{-10} \Omega$

The Ra Table class has 15 values. The R_a ROM is used to initialize R_a RAM upon gauge reset. Each of these values represents a resistance value normalized at 0°C for the associated Qmax Cell 0 -based SOC grid point as found by the following rules:

For Cell0 Ra M where:

- If $0 \leq M \leq 7$: The data is the resistance normalized at 0° for:
 $SOC = 100\% - (M \times 11.1\%)$
- If $8 \leq M \leq 14$: The data is the resistance normalized at 0° for:
 $SOC = 100\% - [77.7\% + (M - 7) \times 3.3\%]$

This gives a profile of resistance throughout the entire SOC profile of the battery cells concentrating more on the values closer to 0%.

Normal Setting:

These resistance profiles are used by the gauge for the Impedance Track™ algorithm. The only reason this data is displayed and accessible is to give the user the ability to update the resistance data on golden image files. This resistance profile description is for information purposes only. It is not intended to give a detailed functional description for the gauge resistance algorithms. It is important to note that this data is in mΩ and is normalized to 0°C. The following are useful observations to note with this data throughout the application development cycle:

- Watch for negative values in the Ra Table class. Negative numbers in profiles should never be anywhere in this class.
- Watch for smooth consistent transitions from one profile grid point value to the next throughout each profile. As the gauge does resistance profile updates, these values should be roughly consistent from one learned update to another without huge jumps in consecutive grid points.

6.4.4 Calibration Class

6.4.4.1 Data Subclass 104

6.4.4.1.1 Board Offset

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
104	Data	Board Offset	I1	-128	127	0	μV

Board Offset is the second offset register. Its calibrates all that the **CC Offset** does not calibrate out. This includes board layout, sense resistor and copper trace, and other potential offsets that are external to the fuel gauge.

6.4.4.1.2 Internal Temperature Offset (Int Temp Offset)

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
104	Data	Int Temp Offset	I1	-128	127	0	°C

The gauge has a temperature sensor built into the fuel gauge. The **Int Temp Offset** is used for calibrating offset errors in the measurement of the reported *Temperature()* if a known temperature offset exists between the fuel gauge and the battery cell. The gain of the internal temperature sensor is accurate enough that a calibration for gain is not required.

6.4.4.1.3 Pack V Offset

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
104	Data	Pack V Offset	I1	-128	127	0	mV

This is the offset to calibrate the gauge analog-to-digital converter for cell voltage measurement.

Pack V Offset should not require modification by the user. It is modified by the Voltage Calibration function from Calibration mode.

6.4.4.2 CC Cal Subclass 105

6.4.4.2.1 (Coulomb Counter Sense Resistor) CC Offset, CC Gain, CC Delta

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
104	Data	CC Offset	U2	0	65535	0	mV
		CC Gain	F4	0.100	40.00	0.47095	mΩ
		CC Delta	F4	2.98×10 ⁴	1.19×10 ⁶	559538.8	mΩ

CC Offset, **CC Gain**, and **CC Delta** are internal calibration parameters that require no customer changes and provided for debug purposes only.

Two offsets are used for calibrating the offset of the internal coulomb counter, board layout, sense resistor, copper traces, and other offsets from the coulomb counter readings. **CC Offset** is the calibration value that primarily corrects for the offset error of the fuel gauge coulomb counter circuitry. The other offset calibration is **Board Offset** and is described separately. **CC Offset** is a correction for small noise/errors; therefore, to maximize accuracy, it takes about 16 seconds to calibrate the offset. Since it is impractical to do 16-second offset during IC production, the fuel gauge in will periodically perform an **CC Offset** automatic calibration in SLEEP mode. During the automatic calibration the fuel gauge will set the CONTROL_STATUS[CCA] bit.

CC Gain is the gain factor for calibrating sense resistor, trace, and internal coulomb counter errors. It is used in the algorithm that reports *AverageCurrent()*. **CC Delta** is a fixed constant based on **CC Gain** used to cancel out the time base error.

6.4.4.3 Current Subclass 107

6.4.4.3.1 Deadband

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
107	Current	Deadband	U1	0	255	5	mA

The **Deadband** creates a filter window to the reported *AverageCurrent()* register where the current is reported as 0. Any negative current above this value or any positive current below this value is displayed as 0.

Only a few reasons may require changing the default value:

1. If the PCB layout has issues that cause inconsistent board offsets from board to board.
2. An extra noisy environment.

6.4.4.3.2 RDL Tempco

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
107	Current	RDL Tempco	F4	1.0e-20	4.0e+1	0.000393	

The **RDL Tempco** parameter represents the temperature coefficient of the integrated sense resistor formed by a copper trace on the WCSP package redistribution layer (RDL). This constant is used by firmware and there is no expected need to modify it.

6.4.5 Security Class

6.4.5.1 Codes Subclass 112

6.4.5.1.1 Sealed to Unsealed, Unsealed to Full Access

Subclass ID	Subclass	Name	Type	Min	Max	Default	Unit
112	Codes	Sealed to Unsealed	H4	0x0000 0000	0xFFFF FFFF	0x8000 8000	hex

The fuel gauge implements a key-access scheme to transition from SEALED to UNSEALED mode. Once SEALED via the associated subcommand, a unique set of two keys must be sent to the fuel gauge via the *Control()* command to return to UNSEALED mode. The keys must be sent consecutively, with no other data being written to the *Control()* register in between.

When in the SEALED mode, the CONTROL_STATUS [SS] bit is set; but when the **Sealed to Unsealed** keys are correctly received by the fuel gauge, the [SS] bit is cleared. The **Sealed to Unsealed** key has two identical words stored in ROM with a value of 0x80008000. Then *Control()* should supply 0x8000 and 0x8000 (again) to unseal the part.

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